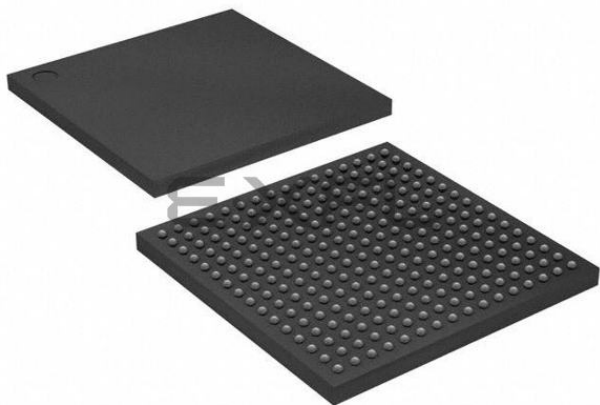




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Applications of Embedded - FPGAs

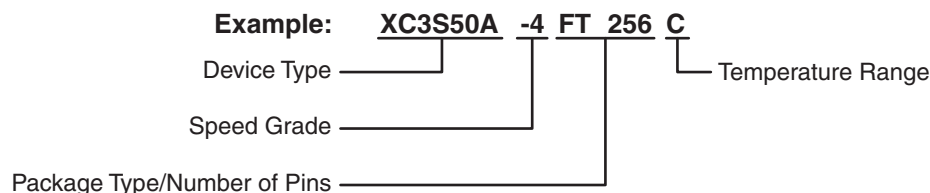
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	176
Number of Logic Elements/Cells	1584
Total RAM Bits	55296
Number of I/O	144
Number of Gates	50000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-LBGA
Supplier Device Package	256-FTBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s50a-5ftg256c

Ordering Information

Spartan-3A FPGAs are available in both standard and Pb-free packaging options for all device/package combinations. The Pb-free packages include a 'G' character in the ordering code.



DS529-1_05_011309

Device	Speed Grade		Package Type / Number of Pins ⁽¹⁾		Temperature Range (T _J)	
XC3S50A	–4	Standard Performance	VQ100/ VQG100	100-pin Very Thin Quad Flat Pack (VQFP)	C	Commercial (0°C to 85°C)
XC3S200A	–5	High Performance (Commercial only)	TQ144/ TQG144	144-pin Thin Quad Flat Pack (TQFP)	I	Industrial (–40°C to 100°C)
XC3S400A			FT256/ FTG256	256-ball Fine-Pitch Thin Ball Grid Array (FTBGA)		
XC3S700A			FG320/ FGG320	320-ball Fine-Pitch Ball Grid Array (FBGA)		
XC3S1400A			FG400/ FGG400	400-ball Fine-Pitch Ball Grid Array (FBGA)		
			FG484/ FGG484	484-ball Fine-Pitch Ball Grid Array (FBGA)		
			FG676/ FGG676	676-ball Fine-Pitch Ball Grid Array (FBGA)		

Notes:

- See [Table 2](#) for specific device/package combinations.
- See [DS681](#) for the XA Automotive Spartan-3A FPGAs.

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/05/06	1.0	Initial release.
02/02/07	1.1	Promoted to Preliminary status. Updated maximum differential I/O count for XC3S50A in Table 1 . Updated differential input-only pin counts in Table 2 .
03/16/07	1.2	Minor formatting updates.
04/23/07	1.3	Added " Production Status " section.
05/08/07	1.4	Updated XC3S400A to Production.
07/10/07	1.4.1	Minor updates.
04/15/08	1.6	Added VQ100 for XC3S50A and XC3S200A and extended FT256 to XC3S700A and XC3S1400A. Added reference to SCD 4103 for 750 Mbps performance.
05/28/08	1.7	Added reference to XA Automotive version.
03/06/09	1.8	Simplified Ordering Information. Added references to Extended Spartan-3A Family. Removed reference to SCD 4103.
08/19/10	2.0	Updated Table 2 to clarify TQ/VQ size.

Power Supply Specifications

Table 5: Supply Voltage Thresholds for Power-On Reset

Symbol	Description	Min	Max	Units
V_{CCINTT}	Threshold for the V_{CCINT} supply	0.4	1.0	V
V_{CCAUXT}	Threshold for the V_{CCAUX} supply	1.0	2.0	V
V_{CCO2T}	Threshold for the V_{CCO} Bank 2 supply	1.0	2.0	V

Notes:

1. V_{CCINT} , V_{CCAUX} , and V_{CCO} supplies to the FPGA can be applied in any order. However, the FPGA's configuration source (Platform Flash, SPI Flash, parallel NOR Flash, microcontroller) might have specific requirements. Check the data sheet for the attached configuration source. Apply V_{CCINT} last for lowest overall power consumption (see [UG331](#) chapter "Powering Spartan-3 Generation FPGAs" for more information).
2. To ensure successful power-on, V_{CCINT} , V_{CCO} Bank 2, and V_{CCAUX} supplies must rise through their respective threshold-voltage ranges with no dips at any point.

Table 6: Supply Voltage Ramp Rate

Symbol	Description	Min	Max	Units
V_{CCINTR}	Ramp rate from GND to valid V_{CCINT} supply level	0.2	100	ms
V_{CCAUXR}	Ramp rate from GND to valid V_{CCAUX} supply level	0.2	100	ms
V_{CCO2R}	Ramp rate from GND to valid V_{CCO} Bank 2 supply level	0.2	100	ms

Notes:

1. V_{CCINT} , V_{CCAUX} , and V_{CCO} supplies to the FPGA can be applied in any order. However, the FPGA's configuration source (Platform Flash, SPI Flash, parallel NOR Flash, microcontroller) might have specific requirements. Check the data sheet for the attached configuration source. Apply V_{CCINT} last for lowest overall power consumption (see [UG331](#) chapter "Powering Spartan-3 Generation FPGAs" for more information).
2. To ensure successful power-on, V_{CCINT} , V_{CCO} Bank 2, and V_{CCAUX} supplies must rise through their respective threshold-voltage ranges with no dips at any point.

Table 7: Supply Voltage Levels Necessary for Preserving CMOS Configuration Latch (CCL) Contents and RAM Data

Symbol	Description	Min	Units
V_{DRINT}	V_{CCINT} level required to retain CMOS Configuration Latch (CCL) and RAM data	1.0	V
V_{DRAUX}	V_{CCAUX} level required to retain CMOS Configuration Latch (CCL) and RAM data	2.0	V

External Termination Requirements for Differential I/O

LVDS, RSDS, MINI_LVDS, and PPDS I/O Standards

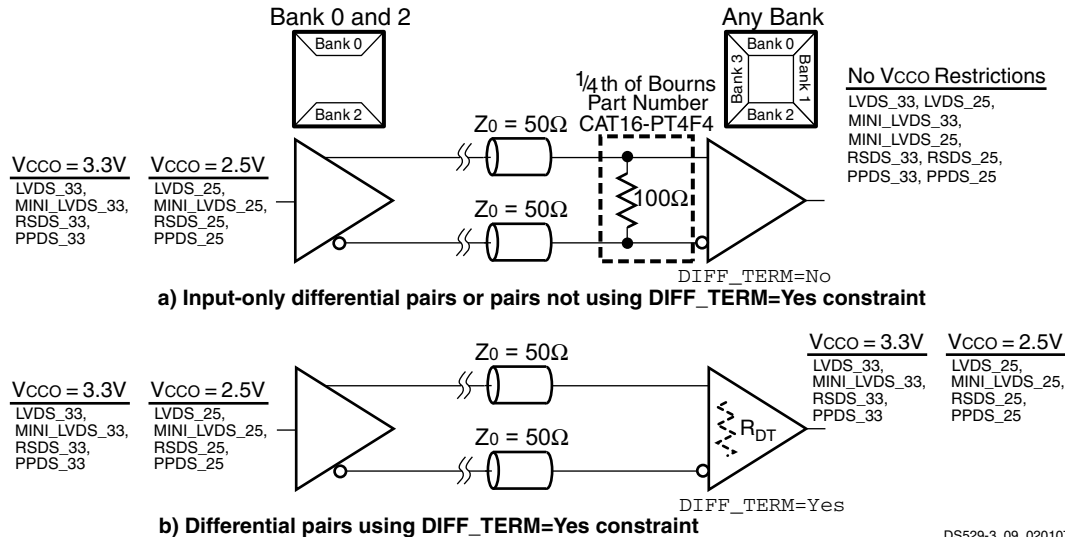


Figure 6: External Input Termination for LVDS, RSDS, MINI_LVDS, and PPDS I/O Standards

BLVDS_25 I/O Standard

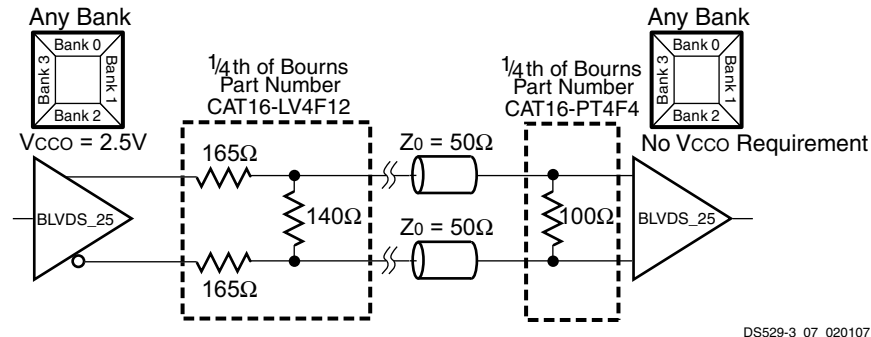


Figure 7: External Output and Input Termination Resistors for BLVDS_25 I/O Standard

TMDS_33 I/O Standard

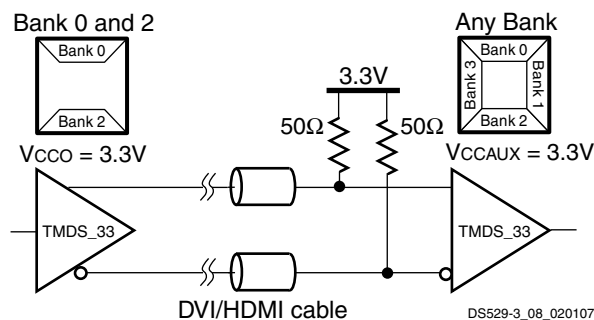


Figure 8: External Input Resistors Required for TMDS_33 I/O Standard

Device DNA Read Endurance

Table 15: Device DNA Identifier Memory Characteristics

Symbol	Description	Minimum	Units
DNA_CYCLES	Number of READ operations or JTAG ISC_DNA read operations. Unaffected by HOLD or SHIFT operations.	30,000,000	Read cycles

Table 22: Propagation Times for the IOB Input Path(Continued)

Symbol	Description	Conditions	DELAY_VALUE	Device	Speed Grade		Units
					-5	-4	
					Max	Max	
T _{IOPID}	The time it takes for data to travel from the Input pin to the I output with the input delay programmed	LVCMOS25 ⁽²⁾	5	XC3S1400A	3.17	3.52	ns
			6		3.52	3.92	ns
			7		3.82	4.18	ns
			8		4.10	4.57	ns
			9		3.84	4.31	ns
			10		4.20	4.79	ns
			11		4.46	5.06	ns
			12		4.87	5.51	ns
			13		5.07	5.73	ns
			14		5.43	6.08	ns
			15		5.73	6.33	ns
			16		6.01	6.77	ns
T _{IOPLI}	The time it takes for data to travel from the Input pin through the IFF latch to the I output with no input delay programmed	LVCMOS25 ⁽²⁾	IFD_DELAY_VALUE=0	XC3S50A	1.70	1.81	ns
				XC3S200A	1.85	2.04	ns
				XC3S400A	1.44	1.74	ns
				XC3S700A	1.48	1.74	ns
				XC3S1400A	1.50	1.97	ns
T _{IOPLID}	The time it takes for data to travel from the Input pin through the IFF latch to the I output with the input delay programmed	LVCMOS25 ⁽²⁾	1	XC3S50A	2.30	2.41	ns
			2		3.24	3.35	ns
			3		3.65	3.98	ns
			4		4.18	4.55	ns
			5		4.02	4.47	ns
			6		4.86	5.32	ns
			7		5.61	6.17	ns
			8		6.11	6.75	ns
			1	XC3S200A	2.19	2.43	ns
			2		2.86	3.16	ns
			3		3.52	4.01	ns
			4		4.02	4.60	ns
			5		3.83	4.43	ns
			6		4.70	5.46	ns
			7		5.48	6.33	ns
			8		5.99	6.94	ns
			1	XC3S400A	1.93	2.25	ns
			2		2.57	2.90	ns
			3		3.16	3.66	ns
			4		3.63	4.19	ns

Table 27: Test Methods for Timing Measurement at I/Os(Continued)

Signal Standard (IOSTANDARD)	Inputs			Outputs		Inputs and Outputs
	V _{REF} (V)	V _L (V)	V _H (V)	R _T (Ω)	V _T (V)	V _M (V)
Differential						
LVDS_25	-	V _{ICM} - 0.125	V _{ICM} + 0.125	50	1.2	V _{ICM}
LVDS_33	-	V _{ICM} - 0.125	V _{ICM} + 0.125	50	1.2	V _{ICM}
BLVDS_25	-	V _{ICM} - 0.125	V _{ICM} + 0.125	1M	0	V _{ICM}
MINI_LVDS_25	-	V _{ICM} - 0.125	V _{ICM} + 0.125	50	1.2	V _{ICM}
MINI_LVDS_33	-	V _{ICM} - 0.125	V _{ICM} + 0.125	50	1.2	V _{ICM}
LVPECL_25	-	V _{ICM} - 0.3	V _{ICM} + 0.3	N/A	N/A	V _{ICM}
LVPECL_33	-	V _{ICM} - 0.3	V _{ICM} + 0.3	N/A	N/A	V _{ICM}
RSDS_25	-	V _{ICM} - 0.1	V _{ICM} + 0.1	50	1.2	V _{ICM}
RSDS_33	-	V _{ICM} - 0.1	V _{ICM} + 0.1	50	1.2	V _{ICM}
TMDS_33	-	V _{ICM} - 0.1	V _{ICM} + 0.1	50	3.3	V _{ICM}
PPDS_25	-	V _{ICM} - 0.1	V _{ICM} + 0.1	50	0.8	V _{ICM}
PPDS_33	-	V _{ICM} - 0.1	V _{ICM} + 0.1	50	0.8	V _{ICM}
DIFF_HSTL_I	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	0.75	V _{ICM}
DIFF_HSTL_III	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	1.5	V _{ICM}
DIFF_HSTL_I_18	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	0.9	V _{ICM}
DIFF_HSTL_II_18	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	0.9	V _{ICM}
DIFF_HSTL_III_18	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	1.8	V _{ICM}
DIFF_SSTL18_I	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	0.9	V _{ICM}
DIFF_SSTL18_II	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	0.9	V _{ICM}
DIFF_SSTL2_I	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	1.25	V _{ICM}
DIFF_SSTL2_II	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	1.25	V _{ICM}
DIFF_SSTL3_I	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	1.5	V _{ICM}
DIFF_SSTL3_II	-	V _{ICM} - 0.5	V _{ICM} + 0.5	50	1.5	V _{ICM}

Notes:

- Descriptions of the relevant symbols are as follows:
V_{REF} – The reference voltage for setting the input switching threshold
V_{ICM} – The common mode input voltage
V_M – Voltage of measurement point on signal transition
V_L – Low-level test voltage at Input pin
V_H – High-level test voltage at Input pin
R_T – Effective termination resistance, which takes on a value of 1 MΩ when no parallel termination is required
V_T – Termination voltage
- The load capacitance (C_L) at the Output pin is 0 pF for all signal standards.
- According to the PCI specification.

The capacitive load (C_L) is connected between the output and GND. *The Output timing for all standards, as published in the speed files and the data sheet, is always based on a C_L value of zero.* High-impedance probes (less than 1 pF) are used for all measurements. Any delay that the test fixture might contribute to test measurements is subtracted from those measurements to produce the final timing numbers as published in the speed files and data sheet.

Table 29: Recommended Number of Simultaneously Switching Outputs per VCCO-GND Pair ($V_{CCAUX}=3.3V$)(Continued)

Signal Standard (IOSTANDARD)			Package Type			
			VQ100, TQ144		FT256, FG320, FG400, FG484, FG676	
			Top, Bottom (Banks 0,2)	Left, Right (Banks 1,3)	Top, Bottom (Banks 0,2)	Left, Right (Banks 1,3)
LVCMOS25	Slow	2	16	16	76	76
		4	10	10	46	46
		6	8	8	33	33
		8	7	7	24	24
		12	6	6	18	18
		16	—	6	—	11
		24	—	5	—	7
	Fast	2	12	12	18	18
		4	10	10	14	14
		6	8	8	6	6
		8	6	6	6	6
		12	3	3	3	3
		16	—	3	—	3
		24	—	2	—	2
	QuietIO	2	36	36	76	76
		4	30	30	60	60
		6	24	24	48	48
		8	20	20	36	36
		12	12	12	36	36
		16	—	12	—	36
		24	—	8	—	8
LVCMOS18	Slow	2	13	13	64	64
		4	8	8	34	34
		6	8	8	22	22
		8	7	7	18	18
		12	—	5	—	13
		16	—	5	—	10
	Fast	2	13	13	18	18
		4	8	8	9	9
		6	7	7	7	7
		8	4	4	4	4
		12	—	4	—	4
		16	—	3	—	3
	QuietIO	2	30	30	64	64
		4	24	24	64	64
		6	20	20	48	48
		8	16	16	36	36
		12	—	12	—	36
		16	—	12	—	24

Table 29: Recommended Number of Simultaneously Switching Outputs per VCCO-GND Pair ($V_{CCAUX}=3.3V$)(Continued)

Signal Standard (IOSTANDARD)			Package Type			
			VQ100, TQ144		FT256, FG320, FG400, FG484, FG676	
					Top, Bottom (Banks 0,2)	Left, Right (Banks 1,3)
LVCMOS15	Slow	2	12	12	55	55
		4	7	7	31	31
		6	7	7	18	18
		8	—	6	—	15
		12	—	5	—	10
	Fast	2	10	10	25	25
		4	7	7	10	10
		6	6	6	6	6
		8	—	4	—	4
		12	—	3	—	3
	QuietIO	2	30	30	70	70
		4	21	21	40	40
		6	18	18	31	31
		8	—	12	—	31
		12	—	12	—	20
LVCMOS12	Slow	2	17	17	40	40
		4	—	13	—	25
		6	—	10	—	18
	Fast	2	12	9	31	31
		4	—	9	—	13
		6	—	9	—	9
	QuietIO	2	36	36	55	55
		4	—	33	—	36
		6	—	27	—	36
PCI33_3			9	9	16	16
PCI66_3			—	9	—	13
HSTL_I			—	11	—	20
HSTL_III			—	7	—	8
HSTL_I_18			13	13	17	17
HSTL_II_18			—	5	—	5
HSTL_III_18			8	8	10	8
SSTL18_I			7	13	7	15
SSTL18_II			—	9	—	9
SSTL2_I			10	10	18	18
SSTL2_II			—	6	—	9
SSTL3_I			7	8	8	10
SSTL3_II			5	6	6	7

18 x 18 Embedded Multiplier Timing

Table 34: 18 x 18 Embedded Multiplier Timing

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Combinatorial Delay						
T _{MULT}	Combinational multiplier propagation delay from the A and B inputs to the P outputs, assuming 18-bit inputs and a 36-bit product (AREG, BREG, and PREG registers unused)	–	4.36	–	4.88	ns
Clock-to-Output Times						
T _{MSCKP_P}	Clock-to-output delay from the active transition of the CLK input to valid data appearing on the P outputs when using the PREG register ^(2,3)	–	0.84	–	1.30	ns
T _{MSCKP_A} T _{MSCKP_B}	Clock-to-output delay from the active transition of the CLK input to valid data appearing on the P outputs when using either the AREG or BREG register ^(2,4)	–	4.44	–	4.97	ns
Setup Times						
T _{MSDCK_P}	Data setup time at the A or B input before the active transition at the CLK when using only the PREG output register (AREG, BREG registers unused) ⁽³⁾	3.56	–	3.98	–	ns
T _{MSDCK_A}	Data setup time at the A input before the active transition at the CLK when using the AREG input register ⁽⁴⁾	0.00	–	0.00	–	ns
T _{MSDCK_B}	Data setup time at the B input before the active transition at the CLK when using the BREG input register ⁽⁴⁾	0.00	–	0.00	–	ns
Hold Times						
T _{MSCKD_P}	Data hold time at the A or B input after the active transition at the CLK when using only the PREG output register (AREG, BREG registers unused) ⁽³⁾	0.00	–	0.00	–	ns
T _{MSCKD_A}	Data hold time at the A input after the active transition at the CLK when using the AREG input register ⁽⁴⁾	0.35	–	0.45	–	ns
T _{MSCKD_B}	Data hold time at the B input after the active transition at the CLK when using the BREG input register ⁽⁴⁾	0.35	–	0.45	–	ns
Clock Frequency						
F _{MULT}	Internal operating frequency for a two-stage 18x18 multiplier using the AREG and BREG input registers and the PREG output register ⁽¹⁾	0	280	0	250	MHz

Notes:

1. Combinational delay is less and pipelined performance is higher when multiplying input data with less than 18 bits.
2. The PREG register is typically used in both single-stage and two-stage pipelined multiplier implementations.
3. The PREG register is typically used when inferring a single-stage multiplier.
4. Input registers AREG or BREG are typically used when inferring a two-stage multiplier.
5. The numbers in this table are based on the operating conditions set forth in [Table 8](#).

Block RAM Timing

Table 35: Block RAM Timing

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Clock-to-Output Times						
T _{RCKO}	When reading from block RAM, the delay from the active transition at the CLK input to data appearing at the DOUT output	–	2.06	–	2.49	ns
Setup Times						
T _{RCKK_ADDR}	Setup time for the ADDR inputs before the active transition at the CLK input of the block RAM	0.32	–	0.36	–	ns
T _{RDCK_DIB}	Setup time for data at the DIN inputs before the active transition at the CLK input of the block RAM	0.28	–	0.31	–	ns
T _{RCKK_ENB}	Setup time for the EN input before the active transition at the CLK input of the block RAM	0.69	–	0.77	–	ns
T _{RCKK_WEB}	Setup time for the WE input before the active transition at the CLK input of the block RAM	1.12	–	1.26	–	ns
Hold Times						
T _{RCKC_ADDR}	Hold time on the ADDR inputs after the active transition at the CLK input	0	–	0	–	ns
T _{RCKD_DIB}	Hold time on the DIN inputs after the active transition at the CLK input	0	–	0	–	ns
T _{RCKC_ENB}	Hold time on the EN input after the active transition at the CLK input	0	–	0	–	ns
T _{RCKC_WEB}	Hold time on the WE input after the active transition at the CLK input	0	–	0	–	ns
Clock Timing						
T _{BPWH}	High pulse width of the CLK signal	1.56	–	1.79	–	ns
T _{BPWL}	Low pulse width of the CLK signal	1.56	–	1.79	–	ns
Clock Frequency						
F _{BRAM}	Block RAM clock frequency	0	320	0	280	MHz

Notes:

1. The numbers in this table are based on the operating conditions set forth in [Table 8](#).

TQ144: 144-lead Thin Quad Flat Package

The XC3S50A is available in the 144-lead thin quad flat package, TQ144.

Table 66 lists all the package pins. They are sorted by bank number and then by pin name. Pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The XC3S50A does not support the address output pins for the Byte-wide Peripheral Interface (BPI) configuration mode.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip

Pinout Table

Table 66: Spartan-3A TQ144 Pinout

Bank	Pin Name	Pin	Type
0	IO_0	P142	I/O
0	IO_L01N_0	P111	I/O
0	IO_L01P_0	P110	I/O
0	IO_L02N_0	P113	I/O
0	IO_L02P_0/VREF_0	P112	VREF
0	IO_L03N_0	P117	I/O
0	IO_L03P_0	P115	I/O
0	IO_L04N_0	P116	I/O
0	IO_L04P_0	P114	I/O
0	IO_L05N_0	P121	I/O
0	IO_L05P_0	P120	I/O
0	IO_L06N_0/GCLK5	P126	GCLK
0	IO_L06P_0/GCLK4	P124	GCLK
0	IO_L07N_0/GCLK7	P127	GCLK
0	IO_L07P_0/GCLK6	P125	GCLK
0	IO_L08N_0/GCLK9	P131	GCLK
0	IO_L08P_0/GCLK8	P129	GCLK
0	IO_L09N_0/GCLK11	P132	GCLK
0	IO_L09P_0/GCLK10	P130	GCLK
0	IO_L10N_0	P135	I/O
0	IO_L10P_0	P134	I/O
0	IO_L11N_0	P139	I/O
0	IO_L11P_0	P138	I/O
0	IO_L12N_0/PUDC_B	P143	DUAL
0	IO_L12P_0/VREF_0	P141	VREF
0	IP_0	P140	INPUT

Table 66: Spartan-3A TQ144 Pinout(Continued)

Bank	Pin Name	Pin	Type
0	IP_0/VREF_0	P123	VREF
0	VCCO_0	P119	VCCO
0	VCCO_0	P136	VCCO
1	IO_1	P79	I/O
1	IO_L01N_1/LDC2	P78	DUAL
1	IO_L01P_1/HDC	P76	DUAL
1	IO_L02N_1/LDC0	P77	DUAL
1	IO_L02P_1/LDC1	P75	DUAL
1	IO_L03N_1	P84	I/O
1	IO_L03P_1	P82	I/O
1	IO_L04N_1/RHCLK1	P85	RHCLK
1	IO_L04P_1/RHCLK0	P83	RHCLK
1	IO_L05N_1/TRDY1/RHCLK3	P88	RHCLK
1	IO_L05P_1/RHCLK2	P87	RHCLK
1	IO_L06N_1/RHCLK5	P92	RHCLK
1	IO_L06P_1/RHCLK4	P90	RHCLK
1	IO_L07N_1/RHCLK7	P93	RHCLK
1	IO_L07P_1/IRDY1/RHCLK6	P91	RHCLK
1	IO_L08N_1	P98	I/O
1	IO_L08P_1	P96	I/O
1	IO_L09N_1	P101	I/O
1	IO_L09P_1	P99	I/O
1	IO_L10N_1	P104	I/O
1	IO_L10P_1	P102	I/O
1	IO_L11N_1	P105	I/O
1	IO_L11P_1	P103	I/O
1	IP_1/VREF_1	P80	VREF
1	IP_1/VREF_1	P97	VREF
1	VCCO_1	P86	VCCO
1	VCCO_1	P95	VCCO
2	IO_2/MOSI/CSI_B	P62	DUAL
2	IO_L01N_2/M0	P38	DUAL
2	IO_L01P_2/M1	P37	DUAL
2	IO_L02N_2/CSO_B	P41	DUAL
2	IO_L02P_2/M2	P39	DUAL
2	IO_L03N_2/VS1	P44	DUAL
2	IO_L03P_2/RDWR_B	P42	DUAL
2	IO_L04N_2/VS0	P45	DUAL
2	IO_L04P_2/VS2	P43	DUAL
2	IO_L05N_2/D7	P48	DUAL

User I/Os by Bank

Table 67 indicates how the 108 available user-I/O pins are distributed between the four I/O banks on the TQ144 package. The AWAKE pin is counted as a dual-purpose I/O.

Table 67: User I/Os Per Bank for the XC3S50A in the TQ144 Package

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	INPUT	DUAL	VREF	CLK
Top	0	27	14	1	1	3	8
Right	1	25	11	0	4	2	8
Bottom	2	30	2	0	21	1	6
Left	3	26	15	1	0	2	8
TOTAL		108	42	2	26	8	30

Footprint Migration Differences

The XC3S50A FPGA is the only Spartan-3A device offered in the TQ144 package.

Table 69: Spartan-3A FT256 Pinout (XC3S700A,

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
3	IO_L16N_3	L2	I/O
3	IO_L16P_3/VREF_3	L1	VREF
3	IO_L18N_3	L3	I/O
3	IO_L18P_3	K4	I/O
3	IO_L19N_3	L4	I/O
3	IO_L19P_3	M3	I/O
3	IO_L20N_3	N1	I/O
3	IO_L20P_3	M1	I/O
3	IO_L22N_3	P1	I/O
3	IO_L22P_3/VREF_3	N2	VREF
3	IO_L23N_3	P2	I/O
3	IO_L23P_3	R1	I/O
3	IO_L24N_3	M4	I/O
3	IO_L24P_3	N3	I/O
3	IP_3	J4	INPUT
3	IP_3/VREF_3	G4	VREF
3	IP_3/VREF_3	J5	VREF
3	VCCO_3	D2	VCCO
3	VCCO_3	H2	VCCO
3	VCCO_3	M2	VCCO
GND	GND	A1	GND
GND	GND	A16	GND
GND	GND	B11	GND
GND	GND	B7	GND
GND	GND	C14	GND
GND	GND	C3	GND
GND	GND	E10	GND
GND	GND	E12	GND
GND	GND	E5	GND
GND	GND	F11	GND
GND	GND	F2	GND
GND	GND	F6	GND
GND	GND	F7	GND
GND	GND	F8	GND
GND	GND	F9	GND
GND	GND	G10	GND
GND	GND	G12	GND
GND	GND	G15	GND
GND	GND	G5	GND
GND	GND	G6	GND

Table 69: Spartan-3A FT256 Pinout (XC3S700A,

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
GND	GND	G8	GND
GND	GND	H11	GND
GND	GND	H5	GND
GND	GND	H7	GND
GND	GND	H9	GND
GND	GND	J10	GND
GND	GND	J6	GND
GND	GND	J8	GND
GND	GND	K11	GND
GND	GND	K12	GND
GND	GND	K2	GND
GND	GND	K5	GND
GND	GND	K7	GND
GND	GND	K9	GND
GND	GND	L10	GND
GND	GND	L11	GND
GND	GND	L15	GND
GND	GND	L6	GND
GND	GND	L8	GND
GND	GND	M12	GND
GND	GND	M5	GND
GND	GND	M8	GND
GND	GND	N10	GND
GND	GND	N7	GND
GND	GND	P14	GND
GND	GND	P3	GND
GND	GND	R10	GND
GND	GND	R6	GND
GND	GND	T1	GND
GND	GND	T16	GND
VCCAUX	SUSPEND	R16	PWRMGT
VCCAUX	DONE	T15	CONFIG
VCCAUX	PROG_B	A2	CONFIG
VCCAUX	TCK	A15	JTAG
VCCAUX	TDI	B1	JTAG
VCCAUX	TDO	B16	JTAG
VCCAUX	TMS	B2	JTAG
VCCAUX	VCCAUX	D6	VCCAUX
VCCAUX	VCCAUX	E11	VCCAUX
VCCAUX	VCCAUX	F12	VCCAUX

Table 69: Spartan-3A FT256 Pinout (XC3S700A,

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
VCCAUX	VCCAUX	F5	VCCAUX
VCCAUX	VCCAUX	H14	VCCAUX
VCCAUX	VCCAUX	H4	VCCAUX
VCCAUX	VCCAUX	L12	VCCAUX
VCCAUX	VCCAUX	L5	VCCAUX
VCCAUX	VCCAUX	M10	VCCAUX
VCCAUX	VCCAUX	M6	VCCAUX
VCCINT	VCCINT	F10	VCCINT
VCCINT	VCCINT	G11	VCCINT
VCCINT	VCCINT	G7	VCCINT
VCCINT	VCCINT	G9	VCCINT
VCCINT	VCCINT	H10	VCCINT
VCCINT	VCCINT	H6	VCCINT
VCCINT	VCCINT	H8	VCCINT
VCCINT	VCCINT	J11	VCCINT
VCCINT	VCCINT	J7	VCCINT
VCCINT	VCCINT	J9	VCCINT
VCCINT	VCCINT	K10	VCCINT
VCCINT	VCCINT	K6	VCCINT
VCCINT	VCCINT	K8	VCCINT
VCCINT	VCCINT	L7	VCCINT
VCCINT	VCCINT	L9	VCCINT

FT256 Footprint (XC3S50A)

		(Differential Outputs)					Bank 0				(Differential Outputs)						
		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
(High Output Drive)	A	GND	PROG_B	I/O L19P_0	I/O L18P_0	I/O L17P_0	I/O L15P_0	N.C.	I/O L12P_0 GCLK10	I/O L10N_0 GCLK7	I/O L08N_0	I/O L07N_0	N.C.	I/O L04N_0	I/O L04P_0	TCK	GND
	B	TDI	TMS	I/O L19N_0	I/O L18N_0	VCCO_0	I/O L15N_0	GND	I/O L12N_0 GCLK11	VCCO_0	I/O L08P_0	GND	INPUT	VCCO_0	I/O L02N_0	I/O L02P_0 VREF_0	TDO
	C	I/O L01N_3	I/O L01P_3	GND	I/O L20P_0 VREF_0	I/O L17N_0	I/O L16N_0	N.C.	I/O L11P_0 GCLK8	I/O L10P_0 GCLK6	I/O L09P_0 GCLK4	I/O L07P_0	I/O L03P_0	I/O L01N_0	GND	I/O L24N_1	I/O L24P_1
	D	I/O L03P_3	VCCO_3	I/O L02N_3	I/O L02P_3	I/O L20N_0 PUDC_B	INPUT	I/O L16P_0	I/O L11N_0 GCLK9	I/O L09N_0 GCLK5	N.C.	I/O L03N_0	INPUT	I/O L01P_0	I/O L23N_1	I/O L22N_1	I/O L22P_1
(High Output Drive)	E	I/O L03N_3	N.C.	N.C.	INPUT L04P_3	GND	INPUT	N.C.	VCCO_0	INPUT VREF_0	N.C.	VCCAUX	GND	I/O L23P_1	I/O L20P_1	VCCO_1	N.C.
	F	I/O L08P_3	GND	N.C.	INPUT L04N_3 VREF_3	VCCAUX	GND	INPUT	N.C.	INPUT	INPUT	INPUT L25N_1	INPUT L25P_1 VREF_1	I/O L20N_1	N.C.	N.C.	N.C.
	G	I/O L08N_3 VREF_3	I/O L11P_3 LHCLK0	N.C.	N.C.	N.C.	N.C.	VCCINT	GND	VCCINT	GND	INPUT L21N_1	INPUT L21P_1 VREF_1	N.C.	N.C.	GND	N.C.
	H	I/O L11N_3 LHCLK1	VCCO_3	I/O L12P_3 LHCLK2	N.C.	N.C.	N.C.	INPUT L13P_3	VCCINT	GND	INPUT L13P_1	INPUT L13N_1	VCCO_1	N.C.	I/O L14N_1 RHCLK5	I/O L15P_1 IRDY1 RHCLK6	I/O L15N_1 RHCLK7
(High Output Drive)	J	I/O L14N_3 LHCLK5	I/O L14P_3 LHCLK4	I/O L12N_3 IRDY2 LHCLK3	N.C.	VCCO_3	N.C.	INPUT L13N_3	GND	VCCINT	N.C.	N.C.	I/O L10P_1	I/O L10N_1	I/O L14P_1 RHCLK4	VCCO_1	I/O L12N_1 TRDY1 RHCLK3
	K	I/O L15N_3 LHCLK7	GND	I/O L15P_3 TRDY2 LHCLK6	N.C.	INPUT L21P_3	INPUT L21N_3	GND	VCCINT	GND	VCCINT	INPUT L04P_1	INPUT L04N_1 VREF_1	N.C.	I/O L11N_1 RHCLK1	I/O L11P_1 RHCLK0	I/O L12P_1 RHCLK2
	L	N.C.	N.C.	N.C.	N.C.	INPUT L25P_3	INPUT L25N_3 VREF_3	INPUT	INPUT	INPUT VREF_2	INPUT VREF_2	GND	VCCAUX	N.C.	N.C.	GND	N.C.
	M	I/O L20P_3	VCCO_3	N.C.	I/O L24N_3	GND	VCCAUX	INPUT VREF_2	INPUT VREF_2	VCCO_2	N.C.	INPUT VREF_2	GND	N.C.	N.C.	N.C.	N.C.
(High Output Drive)	N	I/O L20N_3	I/O L22P_3	I/O L24P_3	I/O L01P_2 M1	INPUT VREF_2	I/O L03N_2 VS1	N.C.	I/O L08N_2 D4	I/O L11P_2 GCLK0	N.C.	I/O L16N_2	N.C.	I/O L01P_1 HDC	I/O L01N_1 LDC2	VCCO_1	I/O L03N_1
	P	I/O L22N_3	I/O L23N_3	GND	I/O L01N_2 M0	I/O L04N_2 VS0	N.C.	I/O L08P_2 D5	I/O L10P_2 GCLK14	I/O L11N_2 GCLK1	I/O L14P_2 MOSI CSI_B	I/O L16P_2	I/O L17N_2 D3	N.C.	GND	I/O L02N_1 LDC0	I/O L03P_1
	R	I/O L23P_3	I/O L02P_2 M2	I/O L03P_2 RDWR_B	VCCO_2	I/O L06P_2	GND	N.C.	VCCO_2	I/O L12P_2 GCLK2	GND	I/O L15N_2 DOUT	VCCO_2	I/O L20P_2 D1	I/O L20N_2 CCLK	I/O L02P_1 LDC1	SUSPEND
	T	GND	I/O L02N_2 CSO_B	I/O L04P_2 VS2	I/O L05P_2	I/O L05N_2 D7	I/O L06N_2 D6	N.C.	I/O L10N_2 GCLK15	I/O L12N_2 GCLK3	I/O L14N_2	I/O L15P_2 AWAKE	I/O L17P_2 INIT_B	I/O L18P_2 D2	I/O L18N_2 D0 DIN/MISO	DONE	GND
		(Differential Outputs)					Bank 2				(Differential Outputs)						

Figure 20: XC3S50A FT256 Package Footprint (Top View)

53	I/O: Unrestricted, general-purpose user I/O	25	DUAL: Configuration pins, then possible user I/O	15	VREF: User I/O or input voltage reference for bank	2	SUSPEND: Dedicated SUSPEND and dual-purpose AWAKE Power Management pins
20	INPUT: Unrestricted, general-purpose input pin	30	CLK: User I/O, input, or global buffer input	16	VCCO: Output voltage supply for bank		
2	CONFIG: Dedicated configuration pins	4	JTAG: Dedicated JTAG port pins	6	VCCINT: Internal core supply voltage (+1.2V)		
51	N.C.: Not connected (XC3S50A only)	28	GND: Ground	4	VCCAUX: Auxiliary supply voltage		

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
0	IP_0	F12	INPUT
0	IP_0	G7	INPUT
0	IP_0	G8	INPUT
0	IP_0	G9	INPUT
0	IP_0	G11	INPUT
0	IP_0/VREF_0	E10	VREF
0	VCCO_0	B5	VCCO
0	VCCO_0	B14	VCCO
0	VCCO_0	D11	VCCO
0	VCCO_0	E8	VCCO
1	IO_L01N_1/LDC2	T17	DUAL
1	IO_L01P_1/HDC	R16	DUAL
1	IO_L02N_1/LDC0	U18	DUAL
1	IO_L02P_1/LDC1	U17	DUAL
1	IO_L03N_1/A1	R17	DUAL
1	IO_L03P_1/A0	T18	DUAL
1	IO_L05N_1	N16	I/O
1	IO_L05P_1	P16	I/O
1	IO_L06N_1	M14	I/O
1	IO_L06P_1	N15	I/O
1	IO_L07N_1/VREF_1	P18	VREF
1	IO_L07P_1	R18	I/O
1	IO_L09N_1/A3	M17	DUAL
1	IO_L09P_1/A2	M16	DUAL
1	IO_L10N_1/A5	N18	DUAL
1	IO_L10P_1/A4	N17	DUAL
1	IO_L11N_1/A7	L12	DUAL
1	IO_L11P_1/A6	L13	DUAL
1	IO_L13N_1/A9	K16	DUAL
1	IO_L13P_1/A8	L17	DUAL
1	IO_L14N_1/RHCLK1	K17	RHCLK
1	IO_L14P_1/RHCLK0	L18	RHCLK
1	IO_L15N_1/TRDY1/RHCLK3	J17	RHCLK
1	IO_L15P_1/RHCLK2	K18	RHCLK
1	IO_L17N_1/RHCLK5	K15	RHCLK
1	IO_L17P_1/RHCLK4	J16	RHCLK
1	IO_L18N_1/RHCLK7	H17	RHCLK
1	IO_L18P_1/IRDY1/RHCLK6	H18	RHCLK
1	IO_L19N_1/A11	G16	DUAL
1	IO_L19P_1/A10	H16	DUAL

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
1	IO_L21N_1	F17	I/O
1	IO_L21P_1	G17	I/O
1	IO_L22N_1/A13	E18	DUAL
1	IO_L22P_1/A12	F18	DUAL
1	IO_L23N_1/A15	H15	DUAL
1	IO_L23P_1/A14	J14	DUAL
1	IO_L25N_1	D17	I/O
1	IO_L25P_1	D18	I/O
1	IO_L26N_1/A17	E16	DUAL
1	IO_L26P_1/A16	F16	DUAL
1	IO_L27N_1/A19	F15	DUAL
1	IO_L27P_1/A18	G15	DUAL
1	IO_L29N_1/A21	E15	DUAL
1	IO_L29P_1/A20	D16	DUAL
1	IO_L30N_1/A23	B18	DUAL
1	IO_L30P_1/A22	C18	DUAL
1	IO_L31N_1/A25	B17	DUAL
1	IO_L31P_1/A24	C17	DUAL
1	IP_L04N_1/VREF_1	N14	VREF
1	IP_L04P_1	P15	INPUT
1	IP_L08N_1/VREF_1	L14	VREF
1	IP_L08P_1	M13	INPUT
1	IP_L12N_1	L16	INPUT
1	IP_L12P_1/VREF_1	M15	VREF
1	IP_L16N_1	K14	INPUT
1	IP_L16P_1	K13	INPUT
1	IP_L20N_1	J13	INPUT
1	IP_L20P_1/VREF_1	K12	VREF
1	IP_L24N_1	G14	INPUT
1	IP_L24P_1	H13	INPUT
1	IP_L28N_1	G13	INPUT
1	IP_L28P_1/VREF_1	H12	VREF
1	IP_L32N_1	F13	INPUT
1	IP_L32P_1/VREF_1	F14	VREF
1	VCCO_1	E17	VCCO
1	VCCO_1	H14	VCCO
1	VCCO_1	L15	VCCO
1	VCCO_1	P17	VCCO
2	IO_L01N_2/M0	U3	DUAL
2	IO_L01P_2/M1	T3	DUAL

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
2	IO_L02N_2/CSO_B	V3	DUAL
2	IO_L02P_2/M2	V2	DUAL
2	IO_L03N_2/VS2	U4	DUAL
2	IO_L03P_2/RDWR_B	T4	DUAL
2	IO_L04N_2	T5	I/O
2	IO_L04P_2	R5	I/O
2	IO_L05N_2/VS0	V5	DUAL
2	IO_L05P_2/VS1	V4	DUAL
2	IO_L06N_2	U6	I/O
2	IO_L06P_2	T6	I/O
2	IO_L07N_2	P8	I/O
2	IO_L07P_2	N8	I/O
2	IO_L08N_2/D6	T7	DUAL
2	IO_L08P_2/D7	R7	DUAL
2	IO_L09N_2	R9	I/O
2	IO_L09P_2	T8	I/O
2	IO_L10N_2/D4	V6	DUAL
2	IO_L10P_2/D5	U7	DUAL
2	IO_L11N_2/GCLK13	V8	GCLK
2	IO_L11P_2/GCLK12	U8	GCLK
2	IO_L12N_2/GCLK15	V9	GCLK
2	IO_L12P_2/GCLK14	U9	GCLK
2	IO_L13N_2/GCLK1	T10	GCLK
2	IO_L13P_2/GCLK0	U10	GCLK
2	IO_L14N_2/GCLK3	U11	GCLK
2	IO_L14P_2/GCLK2	V11	GCLK
2	IO_L15N_2	R10	I/O
2	IO_L15P_2	P10	I/O
2	IO_L16N_2/MOSI/CSI_B	T11	DUAL
2	IO_L16P_2	R11	I/O
2	IO_L17N_2	V13	I/O
2	IO_L17P_2	U12	I/O
2	IO_L18N_2/DOUT	U13	DUAL
2	IO_L18P_2/AWAKE	T12	PWR MGMT
2	IO_L19N_2	P12	I/O
2	IO_L19P_2	N12	I/O
2	IO_L20N_2/D3	R13	DUAL
2	IO_L20P_2/INIT_B	T13	DUAL
2	IO_L21N_2	T14	I/O

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
2	IO_L21P_2	V14	I/O
2	IO_L22N_2/D1	U15	DUAL
2	IO_L22P_2/D2	V15	DUAL
2	IO_L23N_2	T15	I/O
2	IO_L23P_2	R14	I/O
2	IO_L24N_2/CCLK	U16	DUAL
2	IO_L24P_2/D0/DIN/MISO	V16	DUAL
2	IP_2	M8	INPUT
2	IP_2	M9	INPUT
2	IP_2	M12	INPUT
2	XC3S400A: IP_2 XC3S200A: N.C. (◆)	N7	INPUT
2	IP_2	N9	INPUT
2	IP_2	N11	INPUT
2	IP_2	R6	INPUT
2	IP_2/VREF_2	M11	VREF
2	IP_2/VREF_2	N10	VREF
2	IP_2/VREF_2	P6	VREF
2	IP_2/VREF_2	P7	VREF
2	IP_2/VREF_2	P9	VREF
2	IP_2/VREF_2	P13	VREF
2	XC3S400A: IP_2/VREF_2 XC3S200A: N.C. (◆)	P14	VREF
2	VCCO_2	P11	VCCO
2	VCCO_2	R8	VCCO
2	VCCO_2	U5	VCCO
2	VCCO_2	U14	VCCO
3	IO_L01N_3	C1	I/O
3	IO_L01P_3	C2	I/O
3	IO_L02N_3	B1	I/O
3	IO_L02P_3	B2	I/O
3	IO_L03N_3	D2	I/O
3	IO_L03P_3	D3	I/O
3	IO_L05N_3	G5	I/O
3	IO_L05P_3	F5	I/O
3	IO_L06N_3	E3	I/O
3	IO_L06P_3	F4	I/O
3	IO_L07N_3	E1	I/O
3	IO_L07P_3	D1	I/O
3	IO_L09N_3	G4	I/O
3	IO_L09P_3	F3	I/O

Table 81: Spartan-3A FG400 Pinout(Continued)

Bank	Pin Name	FG400 Ball	Type
2	IO_L28P_2	Y16	I/O
2	IO_L29N_2	U16	I/O
2	IO_L29P_2	V16	I/O
2	IO_L30N_2	Y18	I/O
2	IO_L30P_2	Y17	I/O
2	IO_L31N_2	U17	I/O
2	IO_L31P_2	V17	I/O
2	IO_L32N_2/CCLK	Y19	DUAL
2	IO_L32P_2/D0/DIN/MISO	W18	DUAL
2	IP_2	P9	INPUT
2	IP_2	P12	INPUT
2	IP_2	P13	INPUT
2	IP_2	R8	INPUT
2	IP_2	R10	INPUT
2	IP_2	T11	INPUT
2	IP_2/VREF_2	N9	VREF
2	IP_2/VREF_2	N12	VREF
2	IP_2/VREF_2	P8	VREF
2	IP_2/VREF_2	P10	VREF
2	IP_2/VREF_2	P11	VREF
2	IP_2/VREF_2	R14	VREF
2	VCCO_2	R11	VCCO
2	VCCO_2	U8	VCCO
2	VCCO_2	U14	VCCO
2	VCCO_2	W5	VCCO
2	VCCO_2	W11	VCCO
2	VCCO_2	W17	VCCO
3	IO_L01N_3	D3	I/O
3	IO_L01P_3	D4	I/O
3	IO_L02N_3	C2	I/O
3	IO_L02P_3	B1	I/O
3	IO_L03N_3	D2	I/O
3	IO_L03P_3	C1	I/O
3	IO_L05N_3	E1	I/O
3	IO_L05P_3	D1	I/O
3	IO_L06N_3	G5	I/O
3	IO_L06P_3	F4	I/O
3	IO_L07N_3	J5	I/O
3	IO_L07P_3	J6	I/O
3	IO_L08N_3	H4	I/O

Table 81: Spartan-3A FG400 Pinout(Continued)

Bank	Pin Name	FG400 Ball	Type
3	IO_L08P_3	H6	I/O
3	IO_L09N_3	G4	I/O
3	IO_L09P_3	F3	I/O
3	IO_L10N_3	F2	I/O
3	IO_L10P_3	E3	I/O
3	IO_L12N_3	H2	I/O
3	IO_L12P_3	G3	I/O
3	IO_L13N_3/VREF_3	G1	VREF
3	IO_L13P_3	F1	I/O
3	IO_L14N_3	H3	I/O
3	IO_L14P_3	J4	I/O
3	IO_L16N_3	J2	I/O
3	IO_L16P_3	J3	I/O
3	IO_L17N_3/LHCLK1	K2	LHCLK
3	IO_L17P_3/LHCLK0	J1	LHCLK
3	IO_L18N_3/IRDY2/LHCLK3	L3	LHCLK
3	IO_L18P_3/LHCLK2	K3	LHCLK
3	IO_L20N_3/LHCLK5	L5	LHCLK
3	IO_L20P_3/LHCLK4	K4	LHCLK
3	IO_L21N_3/LHCLK7	M1	LHCLK
3	IO_L21P_3/TRDY2/LHCLK6	L1	LHCLK
3	IO_L22N_3	M3	I/O
3	IO_L22P_3/VREF_3	M2	VREF
3	IO_L24N_3	M5	I/O
3	IO_L24P_3	M4	I/O
3	IO_L25N_3	N2	I/O
3	IO_L25P_3	N1	I/O
3	IO_L26N_3	N4	I/O
3	IO_L26P_3	N3	I/O
3	IO_L28N_3	R1	I/O
3	IO_L28P_3	P1	I/O
3	IO_L29N_3	P4	I/O
3	IO_L29P_3	P3	I/O
3	IO_L30N_3	R3	I/O
3	IO_L30P_3	R2	I/O
3	IO_L32N_3	T2	I/O
3	IO_L32P_3/VREF_3	T1	VREF
3	IO_L33N_3	R4	I/O
3	IO_L33P_3	T3	I/O
3	IO_L34N_3	U3	I/O

Table 83: Spartan-3A FG484 Pinout(Continued)

Bank	Pin Name	FG484 Ball	Type
1	IO_L26P_1/A10	K22	DUAL
1	IO_L28N_1	L19	I/O
1	IO_L28P_1	L18	I/O
1	IO_L29N_1/A13	J20	DUAL
1	IO_L29P_1/A12	J21	DUAL
1	IO_L30N_1/A15	G22	DUAL
1	IO_L30P_1/A14	H22	DUAL
1	IO_L32N_1	K18	I/O
1	IO_L32P_1	K17	I/O
1	IO_L33N_1/A17	H20	DUAL
1	IO_L33P_1/A16	H21	DUAL
1	IO_L34N_1/A19	F21	DUAL
1	IO_L34P_1/A18	F22	DUAL
1	IO_L36N_1	G20	I/O
1	IO_L36P_1	G19	I/O
1	IO_L37N_1	H19	I/O
1	IO_L37P_1	J18	I/O
1	IO_L38N_1	F20	I/O
1	IO_L38P_1	E20	I/O
1	IO_L40N_1	F18	I/O
1	IO_L40P_1	F19	I/O
1	IO_L41N_1	D22	I/O
1	IO_L41P_1	E22	I/O
1	IO_L42N_1	D20	I/O
1	IO_L42P_1	D21	I/O
1	IO_L44N_1/A21	C21	DUAL
1	IO_L44P_1/A20	C22	DUAL
1	IO_L45N_1/A23	B21	DUAL
1	IO_L45P_1/A22	B22	DUAL
1	IO_L46N_1/A25	G17	DUAL
1	IO_L46P_1/A24	G18	DUAL
1	IP_L04N_1/VREF_1	R16	VREF
1	IP_L04P_1	R15	INPUT
1	IP_L08N_1	P16	INPUT
1	IP_L08P_1	P15	INPUT
1	IP_L12N_1/VREF_1	R18	VREF
1	IP_L12P_1	R17	INPUT
1	IP_L16N_1/VREF_1	N16	VREF
1	IP_L16P_1	N15	INPUT
1	IP_L23N_1	M16	INPUT

Table 83: Spartan-3A FG484 Pinout(Continued)

Bank	Pin Name	FG484 Ball	Type
1	IP_L23P_1	M17	INPUT
1	IP_L27N_1	L16	INPUT
1	IP_L27P_1/VREF_1	M15	VREF
1	IP_L31N_1	K16	INPUT
1	IP_L31P_1	L15	INPUT
1	IP_L35N_1	K15	INPUT
1	IP_L35P_1/VREF_1	K14	VREF
1	IP_L39N_1	H18	INPUT
1	IP_L39P_1	H17	INPUT
1	IP_L43N_1/VREF_1	J15	VREF
1	IP_L43P_1	J16	INPUT
1	IP_L47N_1	H15	INPUT
1	IP_L47P_1/VREF_1	H16	VREF
VCCAUX	SUSPEND	U18	PWR MGMT
1	VCCO_1	E21	VCCO
1	VCCO_1	J17	VCCO
1	VCCO_1	K21	VCCO
1	VCCO_1	P17	VCCO
1	VCCO_1	P21	VCCO
1	VCCO_1	V21	VCCO
2	IO_L01N_2/M0	W5	DUAL
2	IO_L01P_2/M1	V6	DUAL
2	IO_L02N_2/CSO_B	Y4	DUAL
2	IO_L02P_2/M2	W4	DUAL
2	IO_L03N_2	AA3	I/O
2	IO_L03P_2	AB2	I/O
2	IO_L04N_2	AA4	I/O
2	IO_L04P_2	AB3	I/O
2	IO_L05N_2	Y5	I/O
2	IO_L05P_2	W6	I/O
2	IO_L06N_2	AB5	I/O
2	IO_L06P_2	AB4	I/O
2	IO_L07N_2	Y6	I/O
2	IO_L07P_2	W7	I/O
2	IO_L08N_2	AB6	I/O
2	IO_L08P_2	AA6	I/O
2	IO_L09N_2/VS2	W9	DUAL
2	IO_L09P_2/RDWR_B	V9	DUAL
2	IO_L10N_2	AB7	I/O

FG676: 676-ball Fine-pitch Ball Grid Array

The 676-ball fine-pitch ball grid array, FG676, supports the XC3S1400A FPGA.

Table 87 lists all the FG676 package pins. They are sorted by bank number and then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The XC3S1400A has 17 unconnected balls, indicated as N.C. (No Connection) in Table 87 and with the black diamond character (◆) in Table 87 and Figure 27.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at:

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip

Pinout Table

Table 87: Spartan-3A FG676 Pinout

Bank	Pin Name	FG676 Ball	Type
0	IO_L01N_0	F20	I/O
0	IO_L01P_0	G20	I/O
0	IO_L02N_0	F19	I/O
0	IO_L02P_0/VREF_0	G19	VREF
0	IO_L05N_0	C22	I/O
0	IO_L05P_0	D22	I/O
0	IO_L06N_0	C23	I/O
0	IO_L06P_0	D23	I/O
0	IO_L07N_0	A22	I/O
0	IO_L07P_0	B23	I/O
0	IO_L08N_0	G17	I/O
0	IO_L08P_0	H17	I/O
0	IO_L09N_0	B21	I/O
0	IO_L09P_0	C21	I/O
0	IO_L10N_0	D21	I/O
0	IO_L10P_0	E21	I/O
0	IO_L11N_0	C20	I/O
0	IO_L11P_0	D20	I/O
0	IO_L12N_0	K16	I/O
0	IO_L12P_0	J16	I/O
0	IO_L13N_0	E17	I/O
0	IO_L13P_0	F17	I/O
0	IO_L14N_0	A20	I/O
0	IO_L14P_0/VREF_0	B20	VREF

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
0	IO_L15N_0	A19	I/O
0	IO_L15P_0	B19	I/O
0	IO_L16N_0	H15	I/O
0	IO_L16P_0	G15	I/O
0	IO_L17N_0	C18	I/O
0	IO_L17P_0	D18	I/O
0	IO_L18N_0	A18	I/O
0	IO_L18P_0	B18	I/O
0	IO_L19N_0	B17	I/O
0	IO_L19P_0	C17	I/O
0	IO_L20N_0/VREF_0	E15	VREF
0	IO_L20P_0	F15	I/O
0	IO_L21N_0	C16	I/O
0	IO_L21P_0	D17	I/O
0	IO_L22N_0	C15	I/O
0	IO_L22P_0	D16	I/O
0	IO_L23N_0	A15	I/O
0	IO_L23P_0	B15	I/O
0	IO_L24N_0	F14	I/O
0	IO_L24P_0	E14	I/O
0	IO_L25N_0/GCLK5	J14	GCLK
0	IO_L25P_0/GCLK4	K14	GCLK
0	IO_L26N_0/GCLK7	A14	GCLK
0	IO_L26P_0/GCLK6	B14	GCLK
0	IO_L27N_0/GCLK9	G13	GCLK
0	IO_L27P_0/GCLK8	F13	GCLK
0	IO_L28N_0/GCLK11	C13	GCLK
0	IO_L28P_0/GCLK10	B13	GCLK
0	IO_L29N_0	B12	I/O
0	IO_L29P_0	A12	I/O
0	IO_L30N_0	C12	I/O
0	IO_L30P_0	D13	I/O
0	IO_L31N_0	F12	I/O
0	IO_L31P_0	E12	I/O
0	IO_L32N_0/VREF_0	D11	VREF
0	IO_L32P_0	C11	I/O
0	IO_L33N_0	B10	I/O
0	IO_L33P_0	A10	I/O

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
0	IO_L34N_0	D10	I/O
0	IO_L34P_0	C10	I/O
0	IO_L35N_0	H12	I/O
0	IO_L35P_0	G12	I/O
0	IO_L36N_0	B9	I/O
0	IO_L36P_0	A9	I/O
0	IO_L37N_0	D9	I/O
0	IO_L37P_0	E10	I/O
0	IO_L38N_0	B8	I/O
0	IO_L38P_0	A8	I/O
0	IO_L39N_0	K12	I/O
0	IO_L39P_0	J12	I/O
0	IO_L40N_0	D8	I/O
0	IO_L40P_0	C8	I/O
0	IO_L41N_0	C6	I/O
0	IO_L41P_0	B6	I/O
0	IO_L42N_0	C7	I/O
0	IO_L42P_0	B7	I/O
0	IO_L43N_0	K11	I/O
0	IO_L43P_0	J11	I/O
0	IO_L44N_0	D6	I/O
0	IO_L44P_0	C5	I/O
0	IO_L45N_0	B4	I/O
0	IO_L45P_0	A4	I/O
0	IO_L46N_0	H10	I/O
0	IO_L46P_0	G10	I/O
0	IO_L47N_0	H9	I/O
0	IO_L47P_0	G9	I/O
0	IO_L48N_0	E7	I/O
0	IO_L48P_0	F7	I/O
0	IO_L51N_0	B3	I/O
0	IO_L51P_0	A3	I/O
0	IO_L52N_0/PUDC_B	G8	DUAL
0	IO_L52P_0/VREF_0	F8	VREF
0	IP_0	A5	INPUT
0	IP_0	A7	INPUT
0	IP_0	A13	INPUT
0	IP_0	A17	INPUT
0	IP_0	A23	INPUT
0	IP_0	C4	INPUT

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
0	IP_0	D12	INPUT
0	IP_0	D15	INPUT
0	IP_0	D19	INPUT
0	IP_0	E11	INPUT
0	IP_0	E18	INPUT
0	IP_0	E20	INPUT
0	IP_0	F10	INPUT
0	IP_0	G14	INPUT
0	IP_0	G16	INPUT
0	IP_0	H13	INPUT
0	IP_0	H18	INPUT
0	IP_0	J10	INPUT
0	IP_0	J13	INPUT
0	IP_0	J15	INPUT
0	IP_0/VREF_0	D7	VREF
0	IP_0/VREF_0	D14	VREF
0	IP_0/VREF_0	G11	VREF
0	IP_0/VREF_0	J17	VREF
0	N.C. (◆)	A24	N.C.
0	N.C. (◆)	B24	N.C.
0	N.C. (◆)	D5	N.C.
0	N.C. (◆)	E9	N.C.
0	N.C. (◆)	F18	N.C.
0	N.C. (◆)	E6	N.C.
0	N.C. (◆)	F9	N.C.
0	N.C. (◆)	G18	N.C.
0	VCCO_0	B5	VCCO
0	VCCO_0	B11	VCCO
0	VCCO_0	B16	VCCO
0	VCCO_0	B22	VCCO
0	VCCO_0	E8	VCCO
0	VCCO_0	E13	VCCO
0	VCCO_0	E19	VCCO
0	VCCO_0	H11	VCCO
0	VCCO_0	H16	VCCO
1	IO_L01N_1/LDC2	Y21	DUAL
1	IO_L01P_1/HDC	Y20	DUAL
1	IO_L02N_1/LDC0	AD25	DUAL
1	IO_L02P_1/LDC1	AE26	DUAL
1	IO_L03N_1/A1	AC24	DUAL

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/05/06	1.0	Initial release.
02/02/07	1.1	Promoted to Preliminary status. Added DOUT pin to DUAL-type pins in Table 57 . Corrected counts for DUAL pins and differential pairs in Table 59 . Corrected minor typographical error on pin names for pin numbers P24 and P25 in Table 66 . Highlighted the differences in differential I/O pairs between the XC3S50A and XC3S200A in the FT256 package, shown in Table 68 and added Table 74 and Table 75 to summarize the differences.
03/16/07	1.2	Corrected minor typographical error in Figure 19 .
04/23/07	1.3	Added reference to compatible Spartan-3A DSP family.
05/08/07	1.4	Added note regarding banking rules.
07/10/07	1.5	Updated Thermal Characteristics in Table 62 .
04/15/08	1.6	Added VQ100 for XC3S50A and XC3S200A and added FT256 for XC3S700A and XCS1400A to Table 58 , Table 59 , and Table 62 . Updated Thermal Characteristics with latest data in Table 62 . Corrected bank for T8 and type for U16 in Table 86 . Removed VREF name on 6 unconnected N.C. pins for XC3S1400A FG676 in Table 87 and Figure 27 . These pins are noted as VREF if migrating up to the XC3SD1800A in Table 89 .
05/28/08	1.7	Added " Package Overview " section.
03/06/09	1.8	Corrected bank designation for SUSPEND to VCCAUX. Corrected bank designation for JTAG pins in XC3S700A and XC3S1400A FT256 to VCCAUX.
08/19/10	2.0	Corrected pin 36 number in Figure 17 and Figure 18 . Noted difference in FT256 P10/T10 function between XC3S50A and larger devices in Table 68 and Table 74 .